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71) Applicant: KABUSHIKI KAISHA TOSHIBA 72, Horikawa-cho Saiwai-ku Kawasaki-shi Kanagawa-ken 210(JP)

2 Inventor: Kaga, Yasuhiro
2-14-10, Shinkoyasu, Kanagawa-ku
Yokohama-shi, Kanagawa-ken(JP)
Inventor: Komatsu, Fumio
1-43-1, Minami-machi
Fuchu-shi, Tokyo-To(JP)

Representative: Lehn, Werner, Dipl.-Ing. et al Hoffmann, Eitle & Partner Patentanwälte Arabellastrasse 4
W-8000 München 81(DE)

(54) Method and apparatus for measuring pattern dimension.

(57) A pattern dimension measuring method for measuring the dimension of a measuring portion of a pattern of a specimen (10) placed on a specimen stage (1d) by controlling a deflector (1b) of a scan type electron microscope (1) capable of setting a desired inclination angle of one of the specimen stage (1d) and a lens barrel, applying an electron beam to the measuring portion of the specimen (10), and image processing a secondary electron signal from the measuring portion, the method comprising: a first step of calculating the distance between top edges of the measuring portion of the pattern by image processing the secondary electron signal when the electron beam is applied to the measuring portion at an inclination angle of zero; a second step of obtaining the number of pixels at a taper portion of the measuring portion of the pattern by image processing the secondary electron signal when the electron beam is applied to the measuring portion at a first predetermined inclination angle which allows to observe the bottom edges; a third step of obtaining the number of pixels at the taper portion by image processing the secondary electron signal when the electron beam is applied to the measuring portion at a second predetermined inclination angle different from the first inclination angle which allows to observe the bottom edges; a fourth step of calculating the taper angle and height of the pattern in accordance with the numbers of pixels of the taper portion obtained at the second and third steps and the first and second predetermined inclination angles; and a fifth step of calculating the distance between the bottom edges of the pattern and the difference ratio between the top edge and bottom edge distances in accordance with the results calculated at the fourth step.

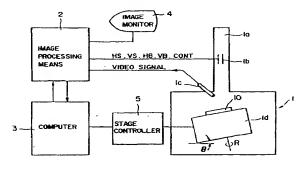


FIG.

Application Number

DOCUMENTS CONSIDERED TO BE RELEVANT			EP 91101682.2	
Category	Citation of document with indication,		Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int. Cl.5)
A	EP - A - 0 345 772 (K.K. TOSHIBA) * Totality *		1-5	G 01 B 15/04 G 01 B 15/00 H 01 J 37/26
A	US - A - 4 725 730 (KATO) * Fig. 5-9; col line 27ff *		1-5	
·				TECHNICAL FIELDS
				G 01 B 15/00
	The present search report has been dra	wn up for all claims  Date of completion of the	search	Extendace
VIENNA 09-1  CATEGORY OF CITED DOCUMENTS  X: particularly relevant if taken alone Y: particularly relevant if combined with another		T: theory E: earlier after D: docu	outpiction of the science of	
A: tech O: non	ument of the same category nological background written disclosure ermediate document		per of the same patent fa	